

FDI Device Package Certificate of Registration



<u>SICK Engineering GmbH</u> Manufacturer	<u>LFR SicWave</u> Model Name
<u>00C7</u> Manufacturer ID (Hex)	<u>C784</u> Device Type (Hex)
<u>0301.fma</u> Device Description File Name	<u>10113530-28a2-4d07-af7b- b5c9160d1b06</u> FDI Device Package ID
<u>SICK_Engineering_GmbH LFR_SicWave.03.01.00.HART.fdx</u> FDI Device Package File Name	<u>03.01.00</u> FDI Package Version
<u>1.2.0</u> FDI Technology Version	<u>L2-06-1000-857</u> Registration Number
<u>DPCTT 1.4.0</u> Test System Versions	<u>FieldComm Group Incorporated</u> Registration Authority
<u>Yes</u> Style Guide Implemented	<u><i>T. J. Mastus</i></u> Approval

2020-04-08

Registration Issue Date

This document is to certify that the above FDI Package is in conformity with FCG.PD10026 and FCG.PD10028 and meets the requirements to be "REGISTERED".



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